SPECIFICATION

 Device Name
 IGBT Module

 Type Name
 : 2MBI100TA-060

 Spec. No. : MS5F 5289

Fuji Electric Co.,Ltd. Matsumoto Factory

DATE NAME APPROVED	Fuji Electric Co.,Ltd.
CHECKED at -23-62 T. Magada 7. Fychira K. Yemada	MS5F 5289 1 14

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Revised Records

Classi-Applied Date fication Ind. Content date Drawn Checked Approved Issued enactment Oct - 22-02 date Revised Reliability J. Kobaysoli test condition (P7/4) α Revision Nov - 29- 02

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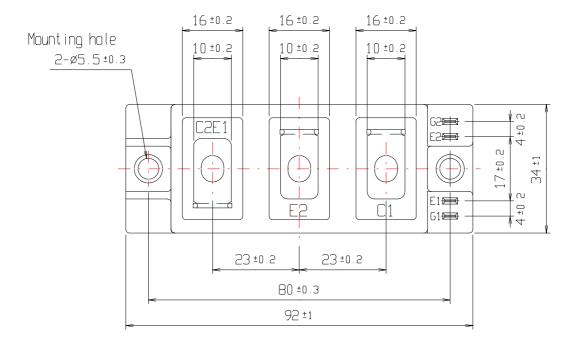
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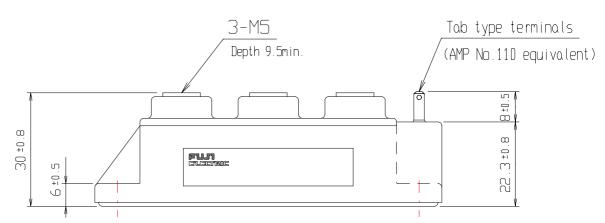
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2MBI100TA-060

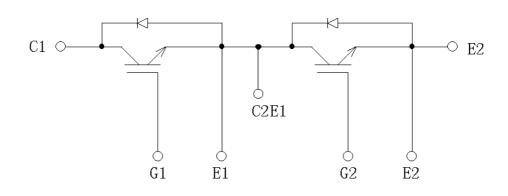
1. Outline Drawing (Unit: mm)





2. Equivalent circuit

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Items	Symbols	Conditions	Maximum Ratings	Units
Collector-Emitter voltage	VCES	lc=1mA	600	V
Gate-Emitter voltage	VGES		±20	V
	lc	Duty=100 %	100	
Collector current	lc pulse	1ms	200	Α
	IF	Duty=50 %	100	
	IF pulse	1ms	200	
Collector Power Dissipation	Pc	1 device	310	W
Junction temperature	Tj		150	°C
Storage temperature	Tstg		-40~ +125	°C
Isolation voltage(*1)	Viso	AC : 1min.	2500	V
Screw Torque	Mounting ^(*2)		3.5	N⋅m
	Terminals ^(*2)		3.5	

(*1) All terminals should be connected together when isolation test will be done.

(*2) Recommendable Value : Mounting 2.5~3.5 N·m (M5) Terminal 2.5~3.5Nm (M5)

4. Electrical characteristics (at Tj= 25°Cunless otherwise specified)

				Cha	aracteris	tics			
Items	Symbols		Conditions		min.	typ.	Max.	Units	
Zero gate voltage Collector current	ICES	VGE =	0 V,	VCE =	600 V	-	-	1.0	mA
Gate-Emitter leakage current	IGES	VCE =	0 V,	VGE =	±20 V	-	-	200	nА
Gate-Emitter threshold voltage	VGE(th)	VCE =	20 V,	Ic =	100 mA	6.2	6.7	7.7	V
Collector-Emitter	VCE(sat)	VGE =	15 V	C	hip	-	1.8	-	V
saturation voltage		Ic =	100 A	Ter	minal	-	2.0	2.4	
Input capacitance	Cies	VGE=	0 V	•		-	8500	-	
Output capacitance	Coes	VCE =	10 V			-	1500	-	pF
Reverse transfer capacitance	Cres	f =	1 MH	z		-	1300	-	
	ton	Vcc =	300 V			-	0.4	1.2	
Turn-on time	tr	lc =	100 A			-	0.25	0.6	
	tr _(i)	VGE =	±15 V			-	0.1	-	μS
Turn-off time	toff	RG =	33 Ω			-	0.4	1.2	
	tf					-	0.04	0.45	
Forward on voltage	VF	IF =	100 A	С	hip	-	1.7	-	V
				Ter	minal	-	2.0	2.5	
Reverse recovery time	trr	IF =	100 A	•		-	-	0.3	μs
Allowabe avalanche energy									
during short circuit cutting off	PAV		lc > 200A	Tj = 125,	5°C	55	-	-	mJ
(Non-repetitive)									

5. Thermal resistance characteristics

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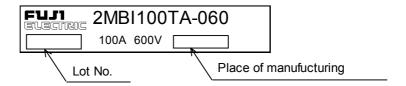
			Characteristics			
Items	Symbols	Conditions	min.	typ.	Max.	Units
Thermal resistance	Rth(j-c)	IGBT	-	-	0.400	
(1 device)		FWD	-	-	1.02	%\M
Contact Thermal resistance	Rth(c-f)	With thermal compound *	-	0.05	-	

^{*} This is the value which is defined mounting on the additional cooling fin with thermal compound.

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6. Indication on module



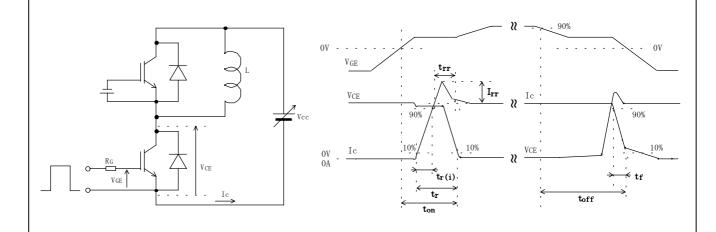
7. Applicable category

This specification is applied to IGBT Module named 2MBI100TA-060

8. Storage and transportation notes

- The module should be stored at a standard temperature of 5 to 35¢ and humidity of 45 to 75%.
- Store modules in a place with few temperature changes in order to avoid condensation on the module surface.
- Avoid exposure to corrosive gases and dust.
- · Avoid excessive external force on the module.
- · Store modules with unprocessed terminals.
- Do not drop or otherwise shock the modules when transporting.

9. Definitions of switching time



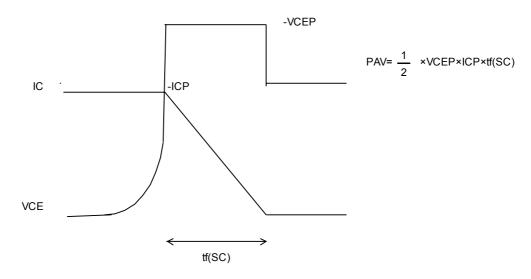
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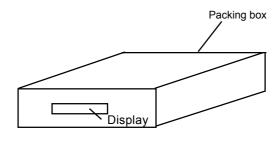
10. Definition of the allowable avalance energy during short circuit cutfing of.



11. UL recognition

This products is recognized by Underwriters Laboratories Inc., the file No. is E82988.

12. Packing and Labeling



* Each modules are packed with electrical protection.

Display on the packing box

- Logo of production
- Type name
- Lot No.
- Products quantity in a packing box

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13. Reliability test results

Reliability Test Items

Test					Reference		Accept-
cate-		Test items	Test m	nethods and conditions	norms	Number	ance
gories		restricins	100111	Tetriods and conditions	EIAJ	of sample	number
901100					ED-4701		Harrison
	1	Terminal Strength	Pull force	: ^a 40N	A - 111	5	(1:0)
		(Pull test)	Test time	: 10±1 sec.	Method 1		
	2	Mounting Strength	Screw torque	: 2.5 ~ 3.5 N·m (M5)	A - 112	5	(1:0)
S							
Mechanical Tests			Test time	: 10±1 sec.	Method 2		
Ė	3	Vibration	Range of frequency:	10 ~ 500Hz	A - 121	5	(1:0)
55			Sweeping time	: 15 min.			
Jar			Acceleration	: ^a 10G			
ect			Sweeping direction:	Each X,Y,Z axis			
Σ			Test time	: 6 hr. (2hr./direction)			
	4	Shock	Maximum acceleration	n : 1000G	A - 122	5	(1:0)
			Pulse width	: 0.5msec.			
			Direction	: Each X,Y,Z axis			
			Test time	: 3 times/direction			
	1	High Temperature	Storage temp.	: 125±5 °C	B - 111	5	(1:0)
		Storage	Test duration	: 1000hr.			(- ,
	2	Low Temperature	Storage temp.	: -40±5 °C	B - 112	5	(1:0)
		Storage	Test duration	: 1000hr.			(,
	3	Temperature	Storage temp.	: 85±3 °C	B - 121	5	(1:0)
	Ů	Humidity	Relative humidity	: 85±5%			(,
		Storage	Test duration	: 1000hr.			
	4	Unsaturated	Test temp.	: 121 °C	B - 123	5	(1:0)
	•	Pressure Cooker	Atmospheric pressure		0		(,
			Autrospriene pressure	(Reference value)			
			Test duration	: 20hr.			
Environment Tests	5	Temperature	1 Cot duration	+3	B - 131	5	(1:0)
Te	Ü	Cycle	Test temp.	: — Low temp40 ⁻⁵ °C	D 101		(1.0)
ent		0,0.0	. 661 16	Low temp. 40 0			
Ĕ				High temp. 125 ⁻⁵ °C			
ī				riigir terrip. 120			
Ş				RT 5~35 °C			
ш			Dwell time	: High ~ RT ~ Low ~ RT			
				1hr. 0.5hr. 1hr. 0.5hr.			
			Number of cycles	: 100 cycles			
	6	Thermal Shock	rumber er eyelee	+0	B - 141	5	(1:0)
	ŭ	THOMAS OFFICER	Test temp.	: ─High temp. 100 -5 °C			(,
				+5			
				Low temp. 0 ⁻⁰ °C			
			I Ised liquid · Water w	vith ice and ^a boiling water			
			Dipping time	: 5 min. par each temp.			
			Transfer time	: 10 sec.			
			Number of cycles				
<u> </u>					l		

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Reliability Test Items

Test cate- gories	Test items	Test	methods and conditions	Reference norms EIAJ ED-4701	Number of sample	Accept- ance number
	1 High temperature Reverse Bias	Test temp. Bias Voltage Bias Method Test duration	+0 : Ta = 125 -5 °C (Tj ≦ 150 °C) : VC = 0.8×VCES : Applied DC voltage to C-E VGE = 0V : 1000hr.	D - 313	5	(1:0)
Endurance Tests	2 High temperature Bias	Test temp. Bias Voltage Bias Method Test duration	: Ta = 125 ⁻⁵ °C (Tj ≦ 150 °C) : VC = VGE = +20V or -20V : Applied DC voltage to G-E VCE = 0V : 1000hr.	D - 323	5	(1:0)
Endu	3 Temperature Humidity Bias	Test temp. Relative humidity Bias Voltage Bias Method Test duration	: 85 +-3°C : 85 +-5% : VC = 0.8×VCES : Applied DC voltage to C-E VGE = 0V : 1000hr.	B - 121	5	(1:0)
	4 Intermitted Operating Life (Power cycle) (for IGBT)	ON time OFF time Test temp. Number of cycles	: 2 sec. : 18 sec. : Δ Tj=100±5 deg Tj ≦ 150 °C, Ta=25±5 °C : 15000 cycles	D - 322	5	(1:0)

Failure Criteria

ltem	Charac	Characteristic Symbol Failure criteria		Unit	Note		
				Lower limit	Upper limit		
Electrical	Leakage curre	ent	ICES	-	USL×2	mA	
characteristic			±IGES	-	USL×2	μΑ	
	Gate threshol	d voltage	VGE(th)	LSL×0.8	USL×1.2	mΑ	
	Saturation vol	tage	VCE(sat)	-	USL×1.2	٧	
	Forward volta	ge	VF	-	USL×1.2	V	
	Thermal	IGBT	∆ VGE	-	USL×1.2	mV	
	resistance		or ∆ VCE				
		FWD	ΔVF	-	USL×1.2	mV	
	Isolation voltage		Viso	Broken i	nsulation	1	
Visual							
inspection			-	The visua	al sample	-	
	and the oth	ners					

LSL: Lower specified limit. USL: Upper specified limit.

Note: Each parameter measurement read-outs shall be made after stabilizing the components at room ambient for 2 hours minimum, 24 hours maximum after removal from the tests. And in case of the wetting tests, for example, moisture resistance tests, each component shall be made wipe or dry completely before the measurement.

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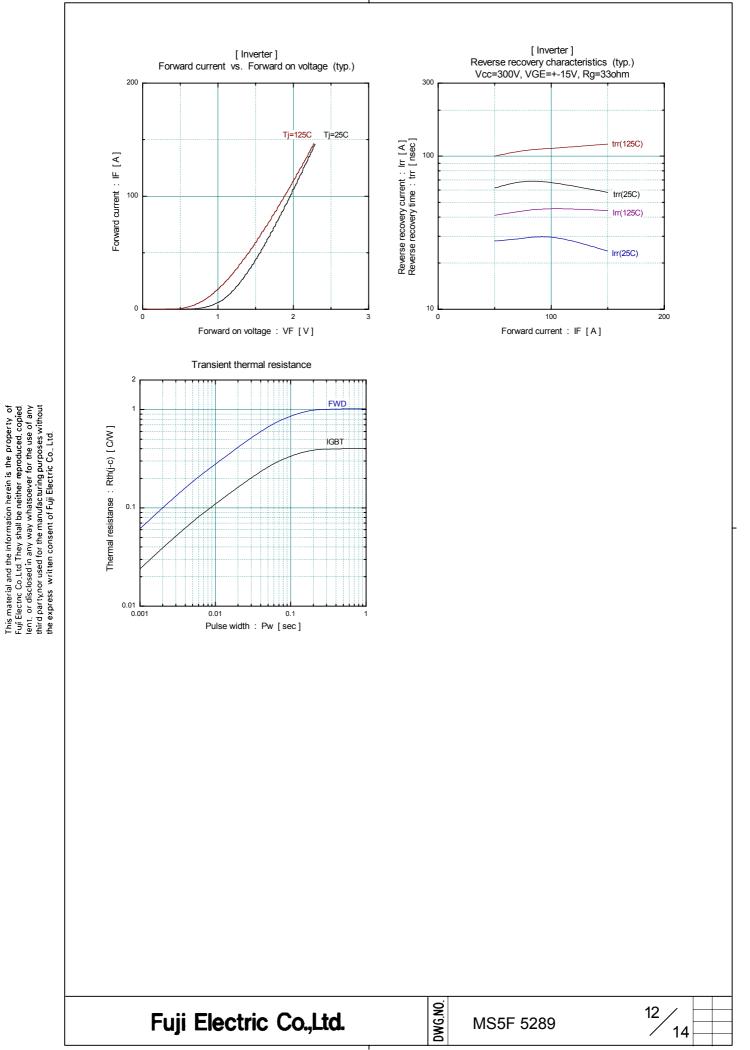
Reliability Test Results

Test cate- gories		Test items	Reference norms EIAJ ED-4701	Number of test sample	Number of failure sample
S	1	Terminal Strength (Pull test)	A - 111 Method 1	5	0
Mechanical Tests	2	Mounting Strength	A - 112 Method 2	5	0
chanic	3	Vibration	A - 121	5	0
Me	4	Shock	A - 122	5	0
	1	High Temperature Storage	B - 111	5	0
sts	2	Low Temperature Storage	B - 112	5	0
Environment Tests	3 Temperature Humidity Storage		B - 121	5	0
vironn	4	Unsaturated Pressure Cooker	B - 123	5	0
ш	5	Temperature Cycle	B - 131	5	0
	6	Thermal Shock	B - 141	5	0
	High temperature Reverse Bias High temperature Bias (for gate)		D - 313	5	0
Endurance Tests			D - 323	5	0
	3 Temperature Humidity Bias		B - 121	5	0
Enc	4 Intermitted Operating Life (Power cycling) (for IGBT)		D - 322	5	0

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Warnings

- This product shall be used within its abusolute maximun rating (voltage, current, and temperature). This product may be broken in case of using beyond the ratings. 製品の絶対最大定格(電圧, 電流, 温度等)の範囲内で御使用下さい。 絶対最大定格を超えて使用すると、素子が破壊する場合があります。
- Conect adequate fuse or protector of circuit between three-phase line and this product to prevent the equipment from causing secondary destruction. 万一の不慮の事故で素子が破壊した場合を考慮し、商用電源と本製品の間に適切な容量のヒューズ又はブレーカーを必ず付けて2次破壊を防いでください。
- Use this product after realizing enough working on environment and considering of product's reliability life. This product may be broken before target life of the system in case of using beyond the product's reliability life. 製品の使用環境を十分に把握し、製品の信頼性寿命が満足できるか検討の上、本製品を適用して下さい。 製品の信頼性寿命を超えて使用した場合、装置の目標寿命より前に素子が破壊する場合があります。
- If the product had been used in the environment with acid, organic matter, and corrosive gas (hydrogen sulfide, sulfurous acid gas), the product's performance and appearance can not be ensured easily.

 酸・有機物・腐食性ガス(硫化水素, 亜硫酸ガス等)を含む環境下で使用された場合、製品機能・外観などの保証は致しかねます。
- Use this product within the power cycle curve(Thechnical Rep.No:MT6M4057) 本製品は、パワーサイクル寿命カーブ以下で使用下さい(技術資料No::MT6M4057)
- Never add mechanical stress to deform the main or control terminal.
 The deformed terminal may cause poor contact probrem.
 主端子及び制御端子に応力を与えて変形させないで下さい。 端子の変形により、接触不良などを引き起こす場合があります。
- According to the outline drawing, select proper length of screw for main terminal.
 Longer screws may break the case.
 本製品に使用する主端子用のネジの長さは、外形図に従い正しく選定下さい。
 ネジが長いとケースが破損する場合があります。
- Use this product with keeping the cooling fin's flatness between screw holes within 100um and the rouphness within 10um. Also keep the tightening torque within the limits of this specification. Improper handling may cause isolation breakdown and this may lead to a cirtical accident. 冷却フィンはネジ取り付け位置間で平坦度を100um以下、表面の粗さは10um以下にして下さい。 誤った取り扱いをすると絶縁破壊を起こし、重大事故に発展する場合があります。
- It shall be confirmed that IGBT's operating locus of the turn-off voltage and current are within the RBSOA specification. This product may be broken if the locus is out of the RBSOA. ターンオフ電圧・電流の動作軌跡がRBSOA仕様内にあることを確認して下さい。 RBSOAの範囲を超えて使用すると素子が破壊する可能性があります。
- If excessive static electricity is applied to the control terminals, the devices can be broken. Implement some countermeasures against static electricity. 制御端子に過大な静電気が印加された場合、素子が破壊する場合があります。取り扱い時は静電気対策を実施して下さい。

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